Electronic properties of low-$\Sigma$ grain boundaries in InAs
Altynbek Murat, Masahiko Matsubara, Binh-Minh Nguyen, and Enrico Bellotti
Phys. Rev. Materials 2, 123604 — Published 27 December 2018
DOI: 10.1103/PhysRevMaterials.2.123604
Electronic Properties of Low-$\Sigma$ Grain Boundaries in InAs

Altynbek Murat,1 Masahiko Matsubara,1 Binh-Minh Nguyen,2 and Enrico Bellotti1,∗

1Department of Electrical and Computer Engineering, Boston University, 8 St. Mary’s Street, Boston, Massachusetts 02215, USA
2HRL Laboratories, 3011 Malibu Canyon Road, Malibu, California 90265, USA

We employ first-principles density functional theory to investigate the electronic and structural properties of grain boundaries (GBs) in InAs. In particular, we study the energetics and passivation mechanisms of representative low-$\Sigma$ GBs, including $\Sigma 3(111)$, $\Sigma 3(112)$, $\Sigma 5(120)$, and $\Sigma 5(130)$, to establish their relative stability and experimental feasibility. We find that the symmetric-tilt twin-boundary $\Sigma 3(111)$ GB is the most stable GB, in excellent agreement with our experimentally characterized GB structures in InAs. In addition to our theoretically predicted GB structures, we systematically study and analyze different configurations of complex multi-fold experimentally observed InAs GB structures. We discuss the effect of different passivations and doping mechanisms on the electronic properties of the GBs. Understanding the exact nature of the GB electronic structure and stability, as well as their passivation mechanisms is a key step for the further development of InAs based optoelectronic devices on silicon and other heterogeneous large-area substrates.

I. INTRODUCTION

Indium arsenide based semiconductor alloys, such as InGaAs and InAsSb, are widely employed in the design of laser diodes and infrared detectors due to their optical and electrical properties1–6. For high performance applications, lattice matched structures, grown on InP or GaSb substrates, are used due to the high material quality and low defect density that can be obtained. Even in the case of lattice mismatched substrates, the ability to grow elastically strained material leads to device-grade epitaxial layers. In the case of low cost applications or heteroepitaxial growth on substrates that are significantly different from the material one wants to grow, the crystallinity of the epitaxial layer is significantly degraded. Interfacial defects, dislocations and polycrystalline region can nucleate and deteriorate the material's optical and electrical properties. In the specific case of InAs it is desirable, for a number of applications involving low cost infrared detectors, to be able to grow device structures on large area silicon wafer where the read-out integrated circuit (ROIC) is fabricated. As a result of the large lattice mismatch between silicon and InAs, the overlayer exhibit a polycrystalline structure in which crystalline regions (grains) are separated by defective boundaries.

Grain boundaries (GBs) between adjacent crystalline regions are complex extended defects7–12 and very challenging to eliminate. Furthermore, they impact not only the electronic properties of the material but also the device operation8,13. Consequently, if it is not feasible to eliminate such GBs, one needs to understand their structure and associated electronic properties to try to mitigate their impact on device performance. For example, growth parameters can be optimized to obtain a specific type of GB that is less problematic than others, or one can try to passivate the dangling bonds in the GB’s cores to eliminate possible trapping states. GBs have been studied in detail for semiconductors used in photovoltaic applications, where polycrystalline materials are widely employed and GBs are known to be both detrimental and beneficial to their efficiency14,15. For example, GBs in polycrystalline solar cell materials, such as CdTe and Cu(In,Ga)Se2, can improve the solar cell performance if they act as a hole barrier that can reduce carrier recombination but can be detrimental if they create deep defect levels, which can act as recombination centers14–22. Moreover, the presence of GBs can be exploited to segregate native defects to improve materials quality for other device applications23–25. Similarly, controlling the GB size in thermoelectric materials can improve their performance as a result of the increased phonon scattering at the GBs.26,27 GBs are very challenging to study theoretically due to their complex atomic structure and their fundamental properties have not been fully investigated, except for a few cases of technologically relevant materials. To the best of our knowledge, GBs properties of polycrystalline zinc-blende InAs have not been studied, either theoretically or experimentally. Recently, a series of studies on GBs in CdTe, which has a similar zinc-blende structure as InAs, have been reported in the literature29–31.

For a given GB, $\Sigma$ is the ratio of the coincident sites lattice unit cell to the standard unit cell and it can be used to describe the GB structures. Based on the coincident site lattice (CSL) theory32, GBs with lower $\Sigma$ values are expected to have lower formation energies. However, recent studies have shown that the $\Sigma$ values cannot be used to predict the energies of broader range of GBs and can only be applicable to specific symmetric-tilt grain boundaries33. It has been found that the symmetric-tilt low-$\Sigma$ GBs are the most stable GBs in CdTe, specifically the $\Sigma 3(111)$ and $\Sigma 3(112)$ GBs, and their atomic structures have been confirmed experimentally using high resolution transmission electron microscopy (HRTEM)28,30,34–38. Furthermore, symmetric-tilt $\Sigma 3$ GBs that were experimentally observed in CdTe have also been shown, by theoretical studies, to be the most stable GBs with lowest formation energies among the other GBs with higher $\Sigma$ values24,25.
In the case of InAs no such study has been performed, consequently it is not known whether \( \Sigma 3(111) \) or \( \Sigma 3(112) \) GBs are also the most stable GBs in zinc-blende InAs. Due to the technological importance of InAs for the design of infrared detectors, and the recent interest in large area deposition of InAs on silicon, it is important to undertake a systematic investigation of GBs in InAs, not only to identify their stable geometrical structures but also to establish their optoelectronic properties.

The aim of this work is twofold: 1) using first-principles density functional approach we investigate the structural and electronic properties of low-\( \Sigma \) GBs in InAs, and 2) based on aberration-corrected scanning transmission electron microscopy (AC-STEM) analysis of InAs layers grown on silicon we identify the relevant GB structures and show that they match our theoretical predictions. In particular we have investigated \( \Sigma 3(111), \Sigma 3(112), \Sigma 5(120), \) and \( \Sigma 5(130) \) GBs, shown in Figure 1. These GB configurations were selected based on previous investigations on CdTe that shares the same zinc-blende crystal structure of InAs. We have studied the energetics and passivation mechanisms of these GBs to establish their relative stability and possible passivation approaches.

The manuscript is organized as follows: Section II describes the theoretical and experimental methods employed in this study. Section III will present the results and discuss them. Finally Section IV will draw the conclusions of the work.

II. METHODS

This section describes the methodology employed to study the structural and electronic properties of the GBs and the experimental procedures used to grow and characterize the InAs layers.

A. Theoretical Methods

The first-principles density functional electronic structure calculations have been performed using the projector augmented (PAW)\(^{39}\) method implemented in the Vienna ab initio Simulation Package (VASP)\(^{40}\). For the formation energy calculations of the GBs, we use the generalized gradient approximation (GGA) in the Perdew, Burke, and Ernzerhof (PBE) parameterization for the exchange correlation functional\(^{41}\). A \( k \)-point grid of \( 4 \times 4 \times 1 \) is used for the Brillouin zone sampling and a cutoff energy of \( 460 \) eV is used for basis function. All the structures were fully relaxed until the remaining force acting on each atom is less than \( 0.02 \) eV/\( \text{Å} \). The optimized InAs lattice constant value is \( 6.001 \, \text{Å} \), in good agreement with the experimental bulk value of \( 6.06 \, \text{Å} \). We have tested several different corrections to the exchange/correlation energy functional in DFT including PBE+U and Heyd-Scuseria-Ernzerhof (HSE) hybrid functionals\(^{42,43}\). We find that PBE+U method with \( U = 11.8 \) eV correction with spin orbit coupling is the most appropriate and computationally efficient, providing an energy gap of \( 0.40 \) eV for bulk InAs. The \( U = 11.8 \) eV has been obtained by tuning the \( U \) value, such that it reflects the correct electronic structure of InAs that has been benchmarked based on the accurate HSE hybrid functional calculations. The symmetric-tilt GBs, as illustrated in Figure 1, were modeled using a slab geometry within the supercell method, to avoid possible interaction between different GBs, as shown in Figure 2. Surface dangling bonds in the supercells were passivated by pseudo-hydrogens with fractional charges of \( 3/4 \) for As and \( 5/4 \) for In, respectively\(^{23}\). Furthermore, the number of InAs layers and at least 20\( \AA \) vacuum on both sides of the GB were selected to minimize the effect of the supercell size on the GB electronic structure.

The slab structures for the \( \Sigma 3(111) \) GB contains 62 In and 62 As atoms with a slab size of \( 8.49 \times 10.39 \times 58.80 \) \( \text{Å} \) whereas the \( \Sigma 3(112) \) GB contains 64 In and 64 As atoms with a size of \( 14.69 \times 8.48 \times 61.58 \) \( \text{Å} \). Similarly, the \( \Sigma 5(120) \) and the \( \Sigma 5(130) \) slab structures have 50 In/As and 66 In/As atoms with slab sizes of \( 6.00 \times 13.41 \times 62.25 \) \( \text{Å} \) and \( 6.00 \times 18.97 \times 62.25 \) \( \text{Å} \), respectively.

The formation energy \( (E_f) \) of the GBs has been calculated as \( E_f = [ E_{tot}(\text{GB}) - \sum_n \mu_i n_i ]/S \), where \( E_{tot}(\text{GB}) \) is the total energy of the slab system with the GB, \( n_i \) is the number of \( i \) atoms (\( i = \text{In}, \text{As}, \) pseudo hydrogens), \( \mu_i \) is the chemical potential of each \( i \) atom, and \( S \) is the GB area in the supercell. The total energy of bulk InAs is equal to the sum of chemical potentials of In and As, \( \mu_{\text{In}} + \mu_{\text{As}} \), when the system is in equilibrium. To avoid clustering of the elements, \( \mu_{\text{In}} \) should be lower than that of bulk tetragonal In, and \( \mu_{\text{As}} \) should be
lower than that of bulk trigonal As. Chemical potentials of pseudo-hydrogen atoms are determined from the surface energies of the corresponding system\textsuperscript{44}. However, for the calculation of relative formation energies, the explicit energy value of hydrogen is not needed because the comparison is relative and energies contributed from the fixed surface atoms cancel out. For the formation energy of the passivated systems, we employ the same approach as above but include the chemical potentials of the corresponding passivating atoms. For each passivating atom, we consider the corresponding elemental phases. For passivation with interstitial atoms, the atom is placed in between the wrong bonds in the core region and allowed to fully relax. For the case of combined vacancy and interstitial passivation, the vacancy is placed in between the wrong bonds as an interstitial atom. The resulting atomic positions of the representative $\Sigma 3(112)$ passivations are presented in the top panels of Figure 5.

B. Experimental Methods

InAs films were grown on Si (001) substrates by Metal Organic Chemical Vapor Deposition (MOCVD) using Trimethyl Indium and Arsine precursors. Prior to the growth, the Si substrates were cleaned with industrial standard RCA process. The InAs growth conditions were tuned for optimal structural properties (via X-ray diffraction, electron microscopy characterizations) while maintaining the low growth temperature constraints ($T \approx 425^\circ C$) for compatibility with future integration with Read Out Integrated Circuits on Silicon\textsuperscript{45}. The InAs layers grown on Si (001) substrates are only relaxed at the cost of the grain boundaries, thus, we dont expect any significant effect on the standard bulk InAs structure in the experimental material. Specimens for transmission electron microscopy (TEM) were prepared by focus ion beam milling using Gallium ions. Aberration-corrected Scanning transmission electron microscopy (AC-STEM) was used to observe InAs crystal structures with atomic resolution under high-angle annular dark field (HAADF) and bright field modes.
FIG. 5. Representative passivation results for InAs $\Sigma 3$ (112) GBs with As core structures, as calculated with PBE+U(=11.8) with spin orbit coupling (SOC). Magenta and green colors represent In and As atoms, respectively. Partial charge densities (yellow bubbles) for each case are plotted on top of the structures.

The analysis of the InAs that have been grown and characterized, we identify both single and multiple GBs and match them to the theoretically predicted structures. Figure 1 presents the atomic structures of representative $\Sigma 3(112)$, $\Sigma 3(111)$, $\Sigma 5(120)$, and $\Sigma 5(130)$ symmetric-tilt GBs considered in this work. The $\Sigma 3(112)$, $\Sigma 5(120)$, and $\Sigma 5(130)$ InAs GB structures have a core (a hollow region with dangling bonds) at the boundary with cation–cation or anion–anion wrong bonds, whereas the $\Sigma 3(111)$ GB does not have any wrong or dangling bonds, as shown in Figure 3(c). For example, $\Sigma 3(112)$ GBs can manifest either as As-core structure with As-As wrong bonds, as in Figure 3(a), or In-core structure with In-In wrong bonds, shown in Figure 3(b). We will use the As/In-core nomenclature to refer to these structures throughout the text. Due to their energetics, wrong bonds of different kinds have different impact on stability and the electronic structure of the GB.
A. InAs $\Sigma 3(112)$ Grain Boundaries

To begin, we investigate the $\Sigma 3(112)$ GB in InAs as our starting model because it has been shown to be the dominant GB in the zinc-blende CdTe and similar II-VI semiconductors and it has been widely studied. The structure of the $\Sigma 3(112)$ twin boundary in InAs is constructed by merging two (112) InAs planes together which results in a hollow region that is formed at the boundary. As mentioned before, the resulting structure can be either In-core (In atoms near the hollow region as in Figures 3(b)) or As-core (As atoms near the hollow region Figures 3(a)) stoichiometric structures with equal number of In and As atoms. Thus, their formation energies do not depend on the constituent chemical potentials. Based on the calculated electronic structure, both $\Sigma 3(112)$ GBs with different cores have metallic behavior with In-gap states induced by the wrong or dangling bonds. Furthermore, we find that the $\Sigma 3(112)$ GB with the As-core structure is more stable, with lower total energy than the In-core structure, with a difference of approximately 1.5 eV in total energy. This is due to the fact that the two As atoms in As-core have stronger bond compared to the two In atoms in the In-core. This is also reflected in the structural properties of the GB. The corresponding bond lengths for As–As and In–In wrong bonds are 2.56 Å and 2.87 Å respectively. Consequently, in this work we will only focus on the lower-energy As–core $\Sigma 3(112)$ GB structure and investigate possible passivation strategies intended to mitigate the effects of the dangling bonds. Figure 4(a) presents the electronic structures of bulk InAs, and Figure 4(b) shows the calculated band structure of the As-core $\Sigma 3(112)$ InAs GB. Bulk InAs has a semiconducting behavior with calculated band gap of 0.40 eV. This is close to the experimental band gap of 0.41 eV, and the value calculated using HSE is of 0.40 eV with spin-orbit coupling and the amount of exact exchange was set to be 29%. The As–core $\Sigma 3(112)$ GB has a metallic behavior, as shown in Figure 4(b), with no band gap with a Fermi level located in the conduction band. In addition to the As–As wrong bonds, this GB also presents 3-coordinated In and 5-coordinated As atoms at the hollow region. As a result, the partial density of states analysis reveals that the states in the gap are localized in the GB region and are indeed due to the wrong and dangling bonds. In order to mitigate the effect and saturate the dangling bonds responsible for the deep gap states, we investigate several passivation approaches and analyze their corresponding formation energies.

B. Passivation of InAs As-core $\Sigma 3(112)$ Grain Boundaries

We have investigated several passivation approaches for the $\Sigma 3(112)$ As-core InAs GB structure, including self-passivation, doping with group-IV (C and Si) and group-II (Be and Zn) elements. The calculated electronic structure of the passivation approaches considered and their relative formation energies for the InAs $\Sigma 3(112)$ As-core GB are summarized in Figure 5 and Figure 6, respectively. We find that most of the approaches lead to imperfect passivation and the corresponding electronic structures are mostly metallic or have a very low energy gaps. Figures 5(a), 5(b), and 5(c) show the electronic structure and partial density of states along with their relative formation energies do not depend on the constituent chemical potentials. Based on the calculated electronic structure, both $\Sigma 3(112)$ GBs with different cores have metallic behavior with In-gap states induced by the wrong or dangling bonds. Furthermore, we find that the $\Sigma 3(112)$ GB with the As-core structure is more stable, with lower total energy than the In-core structure, with a difference of approximately 1.5 eV in total energy. This is due to the fact that the two As atoms in As-core have stronger bond compared to the two In atoms in the In-core. This is also reflected in the structural properties of the GB. The corresponding bond lengths for As–As and In–In wrong bonds are 2.56 Å and 2.87 Å respectively. Consequently, in this work we will only focus on the lower-energy As–core $\Sigma 3(112)$ GB structure and investigate possible passivation strategies intended to mitigate the effects of the dangling bonds. Figure 4(a) presents the electronic structures of bulk InAs, and Figure 4(b) shows the calculated band structure of the As-core $\Sigma 3(112)$ InAs GB. Bulk InAs has a semiconducting behavior with calculated band gap of 0.40 eV. This is close to the experimental band gap of 0.41 eV, and the value calculated using HSE is of 0.40 eV with spin-orbit coupling and the amount of exact exchange was set to be 29%. The As–core $\Sigma 3(112)$ GB has a metallic behavior, as shown in Figure 4(b), with no band gap with a Fermi level located in the conduction band. In addition to the As–As wrong bonds, this GB also presents 3-coordinated In and 5-coordinated As atoms at the hollow region. As a result, the partial density of states analysis reveals that the states in the gap are localized in the GB region and are indeed due to the wrong and dangling bonds. In order to mitigate the effect and saturate the dangling bonds responsible for the deep gap states, we investigate several passivation approaches and analyze their corresponding formation energies.
from As 4p and Si 3p states. In the case of C\textsubscript{i}, the in-gap states are mainly associated with C 2p states. 

Passivation by group-II elements, for example Be\textsubscript{i} and Zn\textsubscript{i}, leads to small band gaps with imperfect passivations. The calculated band gap values are 0.03 eV and 0.07 eV for Be\textsubscript{i} and Zn\textsubscript{i}, respectively. For both cases, the partial charge states in the gap are from As 4p orbitals. In the case of C\textsubscript{i}, the in-gap states are mainly associated with C 2p states.

Passivation by group-II elements, for example Be\textsubscript{i} and Zn\textsubscript{i}, leads to small band gaps with imperfect passivations. The calculated band gap values are 0.03 eV and 0.07 eV for Be\textsubscript{i} and Zn\textsubscript{i}, respectively. For both cases, the partial charge states in the gap are from As 4p orbitals. In the case of C\textsubscript{i}, the in-gap states are mainly associated with C 2p states.

Passivation by group-II elements, for example Be\textsubscript{i} and Zn\textsubscript{i}, leads to small band gaps with imperfect passivations. The calculated band gap values are 0.03 eV and 0.07 eV for Be\textsubscript{i} and Zn\textsubscript{i}, respectively. For both cases, the partial charge states in the gap are from As 4p orbitals. In the case of C\textsubscript{i}, the in-gap states are mainly associated with C 2p states.

Passivation by group-II elements, for example Be\textsubscript{i} and Zn\textsubscript{i}, leads to small band gaps with imperfect passivations. The calculated band gap values are 0.03 eV and 0.07 eV for Be\textsubscript{i} and Zn\textsubscript{i}, respectively. For both cases, the partial charge states in the gap are from As 4p orbitals. In the case of C\textsubscript{i}, the in-gap states are mainly associated with C 2p states.

Passivation by group-II elements, for example Be\textsubscript{i} and Zn\textsubscript{i}, leads to small band gaps with imperfect passivations. The calculated band gap values are 0.03 eV and 0.07 eV for Be\textsubscript{i} and Zn\textsubscript{i}, respectively. For both cases, the partial charge states in the gap are from As 4p orbitals. In the case of C\textsubscript{i}, the in-gap states are mainly associated with C 2p states.

Passivation by group-II elements, for example Be\textsubscript{i} and Zn\textsubscript{i}, leads to small band gaps with imperfect passivations. The calculated band gap values are 0.03 eV and 0.07 eV for Be\textsubscript{i} and Zn\textsubscript{i}, respectively. For both cases, the partial charge states in the gap are from As 4p orbitals. In the case of C\textsubscript{i}, the in-gap states are mainly associated with C 2p states.

Passivation by group-II elements, for example Be\textsubscript{i} and Zn\textsubscript{i}, leads to small band gaps with imperfect passivations. The calculated band gap values are 0.03 eV and 0.07 eV for Be\textsubscript{i} and Zn\textsubscript{i}, respectively. For both cases, the partial charge states in the gap are from As 4p orbitals. In the case of C\textsubscript{i}, the in-gap states are mainly associated with C 2p states.

Passivation by group-II elements, for example Be\textsubscript{i} and Zn\textsubscript{i}, leads to small band gaps with imperfect passivations. The calculated band gap values are 0.03 eV and 0.07 eV for Be\textsubscript{i} and Zn\textsubscript{i}, respectively. For both cases, the partial charge states in the gap are from As 4p orbitals. In the case of C\textsubscript{i}, the in-gap states are mainly associated with C 2p states.

Passivation by group-II elements, for example Be\textsubscript{i} and Zn\textsubscript{i}, leads to small band gaps with imperfect passivations. The calculated band gap values are 0.03 eV and 0.07 eV for Be\textsubscript{i} and Zn\textsubscript{i}, respectively. For both cases, the partial charge states in the gap are from As 4p orbitals. In the case of C\textsubscript{i}, the in-gap states are mainly associated with C 2p states.

Passivation by group-II elements, for example Be\textsubscript{i} and Zn\textsubscript{i}, leads to small band gaps with imperfect passivations. The calculated band gap values are 0.03 eV and 0.07 eV for Be\textsubscript{i} and Zn\textsubscript{i}, respectively. For both cases, the partial charge states in the gap are from As 4p orbitals. In the case of C\textsubscript{i}, the in-gap states are mainly associated with C 2p states.

Passivation by group-II elements, for example Be\textsubscript{i} and Zn\textsubscript{i}, leads to small band gaps with imperfect passivations. The calculated band gap values are 0.03 eV and 0.07 eV for Be\textsubscript{i} and Zn\textsubscript{i}, respectively. For both cases, the partial charge states in the gap are from As 4p orbitals. In the case of C\textsubscript{i}, the in-gap states are mainly associated with C 2p states.

Passivation by group-II elements, for example Be\textsubscript{i} and Zn\textsubscript{i}, leads to small band gaps with imperfect passivations. The calculated band gap values are 0.03 eV and 0.07 eV for Be\textsubscript{i} and Zn\textsubscript{i}, respectively. For both cases, the partial charge states in the gap are from As 4p orbitals. In the case of C\textsubscript{i}, the in-gap states are mainly associated with C 2p states.

Passivation by group-II elements, for example Be\textsubscript{i} and Zn\textsubscript{i}, leads to small band gaps with imperfect passivations. The calculated band gap values are 0.03 eV and 0.07 eV for Be\textsubscript{i} and Zn\textsubscript{i}, respectively. For both cases, the partial charge states in the gap are from As 4p orbitals. In the case of C\textsubscript{i}, the in-gap states are mainly associated with C 2p states.

Passivation by group-II elements, for example Be\textsubscript{i} and Zn\textsubscript{i}, leads to small band gaps with imperfect passivations. The calculated band gap values are 0.03 eV and 0.07 eV for Be\textsubscript{i} and Zn\textsubscript{i}, respectively. For both cases, the partial charge states in the gap are from As 4p orbitals. In the case of C\textsubscript{i}, the in-gap states are mainly associated with C 2p states.

Passivation by group-II elements, for example Be\textsubscript{i} and Zn\textsubscript{i}, leads to small band gaps with imperfect passivations. The calculated band gap values are 0.03 eV and 0.07 eV for Be\textsubscript{i} and Zn\textsubscript{i}, respectively. For both cases, the partial charge states in the gap are from As 4p orbitals. In the case of C\textsubscript{i}, the in-gap states are mainly associated with C 2p states.

Passivation by group-II elements, for example Be\textsubscript{i} and Zn\textsubscript{i}, leads to small band gaps with imperfect passivations. The calculated band gap values are 0.03 eV and 0.07 eV for Be\textsubscript{i} and Zn\textsubscript{i}, respectively. For both cases, the partial charge states in the gap are from As 4p orbitals. In the case of C\textsubscript{i}, the in-gap states are mainly associated with C 2p states.
FIG. 8. (top) Theoretical atomic structures of complex multi-fold Σ3(111) InAs GB with different configurations and boundaries. (bottom) Matching experimentally characterized polycrystalline InAs GB structures (large/purple dots are In, small/green dots are As).

From AC-STEM imaging obtained at the GB it is possible to evince the atomic structure and match it with the prototype GBs we have investigated. Figure 7(b) shows one of such AC-STEM pictures on which it is superimposed the atomistic GB model of a Σ3(111) GB. It is also interesting to notice that the large majority of GBs present in the sample, are of the Σ3(111) kind. In particular, in the single-crystal-like regrown films with improved crystallinity, almost all of the GBs were Σ3(111) type. This is consistent with the theoretical prediction that such GB has the lowest formation energy and as a result it is the most stable low-energy symmetric-tilt GB. It is also important to point out that Σ3(111) is also the most stable symmetric-tilt GB in other zinc-blende materials, for example CdTe.28,30,34,37,38

D. Complex Σ3(111) InAs GBs

Due to the complexity of polycrystalline materials and their grain arrangements, one should expect that multiple GBs be present in the same sample. These can be of the same kind, or an ensemble of different GB configurations. Consequently, it is important to evaluate the effect of multiple GBs and how their configurations affect the electronic structure of the material. Using the same kind of characterization approach, one can also obtain information on how multiple GBs are arranged and their atomic configuration. Since the Σ3(111) symmetric-tilt GB is the one with the lowest formation energy it is not surprising that multiple GB manifest in the material as combinations of multiple Σ3(111) GBs. Figure 8 presents three different configurations of GBs that have been experimentally observed during the characterization of the InAs sample material. These are multi-fold GBs in which the extent of region located between two GBs determines the atomic configuration at the GB. For each one of the three configurations in Figure 8 we report the atomistic model in the upper panel and, in the lower panel, the AC-STEM picture. Figure 8(a) shows the structure of a double Σ3(111) InAs GB composed of two wurtzite regions positioned side by side. For simplicity, we classify this GB by indicating the two regions as type A and type B. Type B GB is basically the inverse structure of type A GB, where the type A GB is the same single Σ3(111) InAs GB which we discussed in Figure 7(c). As a result, we refer to the structure in Figure 8(a) as a AB type GB. Figure 8(b) presents the 2-fold Σ3(111) InAs GB, which consists of two Σ3(111) InAs GB interfaces, type A and type B, referred to as A-B GB. The two boundaries are not a periodic images of each other, but rather a combination of two inversely folded Σ3(111) InAs symmetric-tilt twin-boundaries, separated by 17Å distance. We note that there is some strain in the experimental structure of this configuration, such that the middle region structure between the type A and type B boundaries is in slightly different angle than the opposite sides. Since the investigation of strain is beyond the scope of this work, we have not considered the strained structures in this work. Figure 8(c) presents the experimentally observed complex GB, which is composed by the repetition of two of the AB GBs, separated by 20Å we will refer to this structure as the AB-AB GB. We should notice first that when the A-type and B-type GB are considered separately and isolated one from the other, they have the same electronic structures with the same band gap. However, when they are allowed to interact by changing the distance between them, they reveal a
different electronic properties. Understanding how the electronic structure changes is critical in predicting the potential impact on material properties and eventually on device performance.

A possible way of comparing the three configurations in Figure 8 is to look at the changes in the density of states at the GB region induced by the different configurations. Figure 9 presents the calculated density of states for the three experimentally observed GB configurations shown in Figure 8. We find all three systems to be semiconducting with band gaps dependent on the GB and system size, as illustrated in Figure 9. The calculated band gap values are 0.65 eV, 0.55 eV, and 0.51 eV for the AB, A–B, and AB–AB GB structures, respectively. The calculated band gaps values indicate a trend for which the larger the system is the closer the band gaps get to the ideal bulk value. Furthermore, we find that the contribution to the states near the Fermi level is mainly from the GB states, whereas the states from the interface atoms are far from the Fermi level. Moreover, the partial density of states show that the valence band maximum (VMB) states are mainly from As(p)/In(p) states and the conduction band minimum (CBM) states are hybridized between the s and p states of both In and As.

FIG. 9. Density of states for the representative four experimentally confirmed structures in Figure 8.

E. \(\Sigma 5(120)\) and \(\Sigma 5(130)\) InAs GBs

While the \(\Sigma 3(111)\) GB is the prevalent one in InAs, other GB configurations are also possible. We find that the \(\Sigma 5(120)\) and \(\Sigma 5(130)\) GBs have higher formation energies than the \(\Sigma 3(111)\) and \(\Sigma 3(112)\) structures, as a result they are not as stable as \(\Sigma 3\) GBs and we have chosen not to perform a detailed investigation. Similarly to the \(\Sigma 3(112)\), the \(\Sigma 5(120)\) and \(\Sigma 5(130)\) GB structures have a hollow region at the interface between the crystalline regions with wrong and dangling bonds, as shown in Figures 1(c) and 1(d). As expected, these bonds induce deep gap states, thus the electronic band structure for the both GB structures presents a metallic behavior without a band gap. For the case of \(\Sigma 5(120)\), we find that the As-core structure has lower total energy than In-core by 1.1 eV. Furthermore, \(\Sigma 5(130)\) GB is more stable than \(\Sigma 5(120)\) GB by about 0.13 eV/Å. Investigations of possible passivation mechanism for the \(\Sigma 5\) GBs are beyond the scope of this work, mainly because the experimentally characterized GB atomic structures are primarily \(\Sigma 3(111)\) GBs.

IV. CONCLUSIONS

We have employed a first-principles density functional methodology to systematically investigate the electronic and structural properties of stable GBs in InAs. In particular, we have studied the energetics and passivation mechanisms of low-\(\Sigma\) GBs, to evaluate their relative stability and to predict the structure of experimentally observed GBs in InAs. We have established that the symmetric-tilt \(\Sigma 3(111)\) InAs GB is the most stable GB among all the studied GBs. From AC-STEM characterization of polycrystalline InAs samples we have found that the \(\Sigma 3(111)\) GB is the most prevalent one compared to other low-\(\Sigma\) structures. This is in agreement with our theoretical prediction.

We find that the symmetric-tilt twin-boundary \(\Sigma 3(111)\) GB is the most stable GB, in excellent agreement with our experimentally observed GB structures in polycrystalline InAs. We have also shown that the \(\Sigma 3\) GBs are more stable than the \(\Sigma 5\) GBs, as expected, since the former have been often found to be the most stable GB in zinc-blende materials.

Finally, we have studied the electronic band structures of the representative complex experimental GBs, such as multi-fold \(\Sigma 3(111)\) GBs. We established a trend of multi-fold GB structures by systematically investigating different configurations of experimentally observed GBs in InAs. The results of these representative \(\Sigma 3(111)\) GBs are expected to provide critical insight on the materials properties. We find that configurations of multiple \(\Sigma 3(111)\) lead to a band gap that can be larger than the value normally observed in bulk InAs.

A further understanding of the nature of the GB electronic structure as well as their passivation mechanism is a key step for the further development of large area devices made of polycrystalline InAs materials.

V. ACKNOWLEDGEMENTS

This material is based upon work supported by the United States Air Force under Contract No. FA8650-16-C-7636. Any opinions, findings and conclusions or recommendations expressed in this material are those of the author(s) and do not necessarily reflect the views of the United States Air Force. This research was developed with funding from the Defense Advanced Research Projects Agency (DARPA). The views, opinions and/or
findings expressed are those of the author and should not be interpreted as representing the official views or policies of the Department of Defense or the U.S. Government. The authors would like to thank Dr. Jay Lewis (DARPA-MTO), Dr. Whitney Mason (DARPA-MTO) for the support, Dr. Rajesh D. Rajavel (HRL), Dr. Christian Ratch and Dr. Jonny Dadras (UCLA) for useful discussion.

* bellotti@bu.edu


28 J. D. Major, Semiconductor Science and Technology 31, 093001 (2016).


